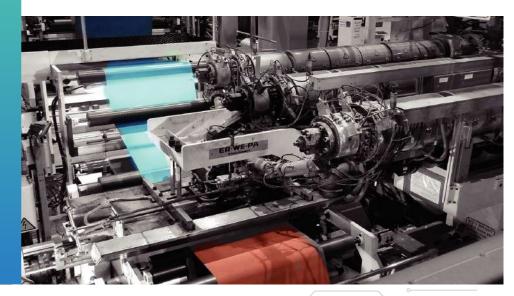


#### **TECHNICAL DATASHEET**

## Blue-PX

BPX235-120-H/H BPX235-60-H/H BPX235-30-H/H BPX235-20-H/H BPX235-16-H/H

PCB Laminate for RF&MW Applications



BluePX is based on PureBlue proprietary polymer chemistry, modification methods and continuous lamination technology.

Both the process, the substrate structure and the composition are protected by existing patents and patent pendings.



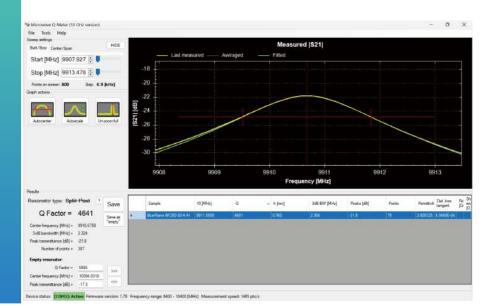


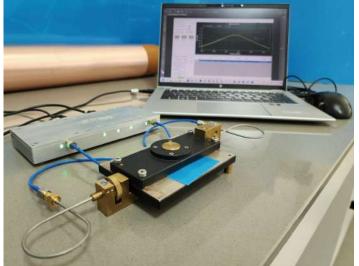
# DATASHEET

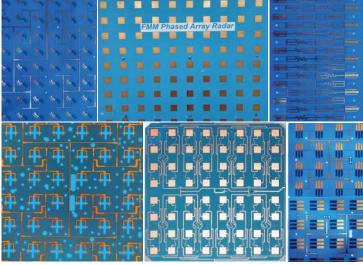
# Blue-PX

BPX235-120-H/H BPX235-60-H/H BPX235-30-H/H BPX235-20-H/H BPX235-16-H/H

PCB Laminate for RF&MW Applications







The Blue-PX laminate is designated to meet manual, robotic and selective wave-soldering assembly processing.

Multiple short time expositions to heat of 130 °C, capacity to continuously operate at above 100 °C.

The absolute glass fiber free system delivers the most isotropic substrate.

The proprietary to PureBlue continuous lamination process of high throughput secures tight thickness tolerance and very narrow uctuation of dielectric constant.

The BPX235 polymer compound features highly cross-linked polyolefin system designated to provide the lowest insertion loss in the most demanding and sensitive RF and MW applications when the lowest possible loss factor is demanded.

Superior balance of mechanical and electrical performance make the BPX245 laminate system the material of choice for your lowest loss high frequency applications.

The isotropic subtrate structure secures substantial advantage in PIM readings vs. anisotropic analogies.

The highest impact was recorded with dense PTH designs, better than -163 dBc under dynamic test and better than -170 dBc under static one.

PIM designated lowest profile foils apply in our performance-on-demand product versions.

#### **Lowest-loss PCB Laminates**





### **Typical Specification Values**

Property	IPC-TM 650 or ASTM	Units	Value	Condition / Remarks	
Dielectric Constant	IPC 2.5.5.5		2.35±0.02	@10 GHz 23 ℃	
Dissipation Factor			0.00034		
Peel Strength	IPC 2.4.8	N/mm	1.8-2.1	Typical	
Moisture Absorption	IPC 2.6.2.1	wt. %	<0.04	Typical	
Volume Resistivity	IPC 2.5.17.1	MΩ - cm	>3X10 <sup>7</sup>		
Surface Resistivity	IPC 2.5.17.1	MΩ - cm	>3X10 <sup>7</sup>		
Dielectric Strength	IPC 2.5.6	kV/mm	19.7		
Flexural Strength, min	IPC 2.4.4	GPa	4		
Thermal Conductivity	ASTM C518	W/m-K	0.22		
x-y CTE, (-45 to 140 °C)	DMA/TMA	ppm/°C	<70		
z CTE, (-45 to 120 °C)	DMA/TMA	ppm/°C	150		
Recommended operational temperature range		°C	-45 to +125	For operation outside this temperature range please ask your technical contact.	
Flammability	UL-94		НВ		
RoHS and Lead Free compatibility			Compatible		



#### **Electro Deposited HTE Copper Foil Specifications**

Typical copper cladding is 15  $\mu$  HTE specified below. Other foil thickness - 12, 18, 24 and 35 may apply per demand. Other foil types may apply - reverse treated, rolled. Copper foil may be replaced with aluminum rolled. Aluminum thickness - 20 to 50  $\mu$ 

Nominal	Area	Tensile strength,	Elongation, %	Resistivity at 20 °C,
thickness, μm	weight, g/m2	N/mm2		Ohm g/m2
15± 1	125 ± 10	> 245	> 3	< 0,162

Continue	Unit	Gauge	IPC	
Feature		25μ	IPC-4562	IPC-MF-650
Shiny side roughness, Ra	μ	0,2-0,4	3.5.6	2.2.17
Matt side roughness, Rz	μ	4-5	3.4.5	2.2.17
Tensile strength, room temperature	MPa,	> 276	3.5.1	2.4.18
Elongation, room temperature	%	> 10	3.5.3	2.4.18
Solderability	Meets requirements	of IPC-4562	3.6.3	2.4.12

### Panel Thickness (excluding copper foil)

BPX235-120-H/H – 3048  $\mu$  / 0.120" with a tolerance of  $\pm$  75  $\mu$ 

BPX235-60-H/H - 1524  $\mu$  / 0.060" with a tolerance of  $\pm$  40  $\mu$ 

BPX235-30-H/H - 760  $\mu$  / 0.030" with a tolerance of  $\pm$  20  $\mu$ 

BPX235-20-H/H - 508  $\mu$  / 0.020" with a tolerance of  $\pm$  15  $\mu$ 

BPX235-16-H/H – 406  $\mu$  / 0.016" with a tolerance of ± 12  $\mu$ 

#### **Panel Dimensions**

- Standard 608X1220 mm
- Panel length may be increased upon arrangement to maximize the yield for massive orders upon arrangement.

#### **Lowest-loss PCB Laminates**

PureBlue Zhongshan Technology Co. Ltd. Zhongshan, Guangdong, China Tel: +33 781523052 Email: manuel@purebluerf.com

Rev. 1.0 2025.09.16